

Certificate US04/3802

SGS

The management system of

FlipChip International, LLC

3701 East University Drive,
Phoenix, AZ 85034

1914 West 3rd Street
Tempe, AZ 85281

has been assessed and certified as meeting the requirements of



ISO 9001:2000

For the following activities

Manufacture of wafer interconnects that enables semiconductor and microelectronic attachment directly to printed circuit board or chip carriers through design, fabrication, wafer thinning, dicing and packaging.

Further clarifications regarding the scope of this certificate and the applicability of ISO 9001:2000 requirements may be obtained by consulting the organization

This certificate is valid from 25 September 2007 until 7 September 2010.
Issue 5. Certified Since September 2004.

Authorized by

Director Accreditation North America



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